

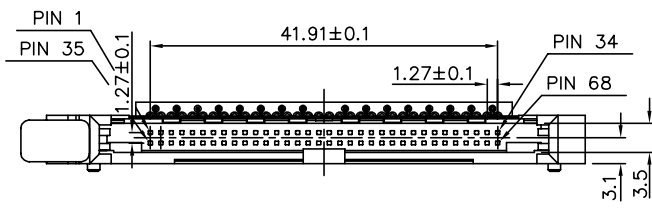
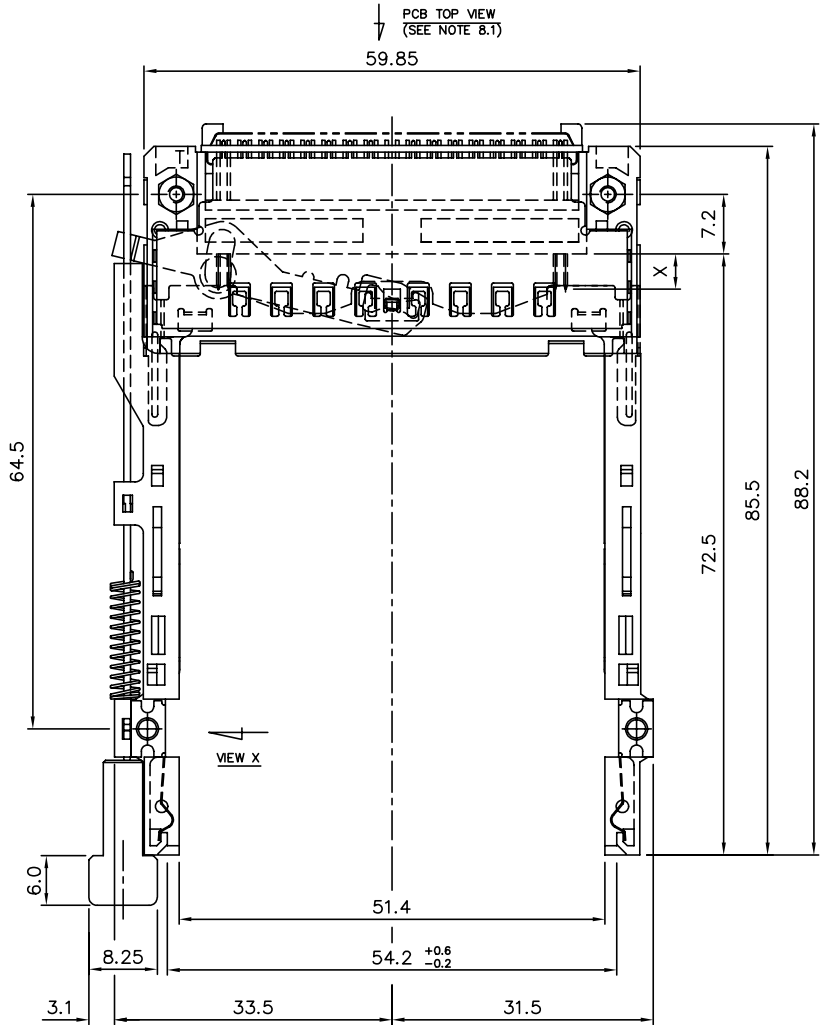
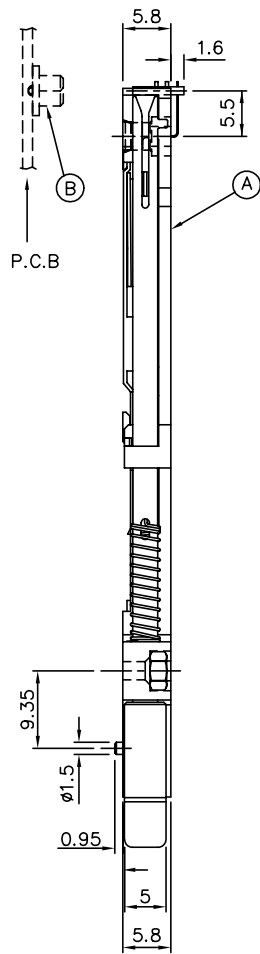
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PRODUCT NO.  
 52366-100DAS/100DASLF

SEE NOTE 8.1 SEE NOTE 8.1



VIEW X  
 (SEE NOTE 8.2)

- NOTES:  
 1 8.0mm MIN CARD EJECT.  
 2 EJECT TRAVEL: 9.50mm  
 3 MATERIAL:  
 EJECT HEADER ASS'Y  
 PLASTIC HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
 PIN: COPPER ALLOY  
 PCB: FR4  
 PLASTIC GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
 PLATE: STAINLESS  
 EMI CONTACT: PHOSPHOR BRONZE  
 4 FINISH  
 PIN:  
 UNDER PLATING: 0.5um MIN. Ni  
 CONTACT AREA: 0.076 μm MIN. GOLD  
 SOLDER TAIL(TIN LEAD OPTION): 2.5um MIN. Sn-Pb  
 SOLDER TAIL(LEAD FREE OPTION): 2.5um MIN. PURE TIN  
 GROUND SHIELD :  
 UNDER PLATING: 0.75um MIN. Ni  
 CONTACT SURFACE: 0.2 um GOLD.  
 5 PUSH ROD LOCATION AND P.C.B. ARE AS APPEARS INSTALLED  
 6 DIM "X"

	4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68	

- DO NOT TOUCH AND KEEP CLEAN THE SURFACES OF PCB OF HEADER ASS'Y.  
 8 SPECIAL FEATURES:  
 8.1 NO CHAMFER OF VTB  
 8.2 NO "S"-SLOT  
 9 IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.  
 10 IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008  
 11 LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION  
 12 PRODUCT SPEC:110-263

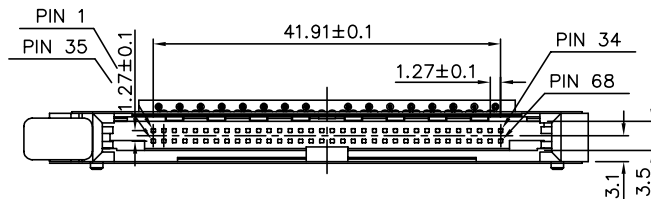
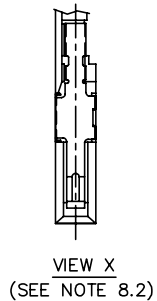
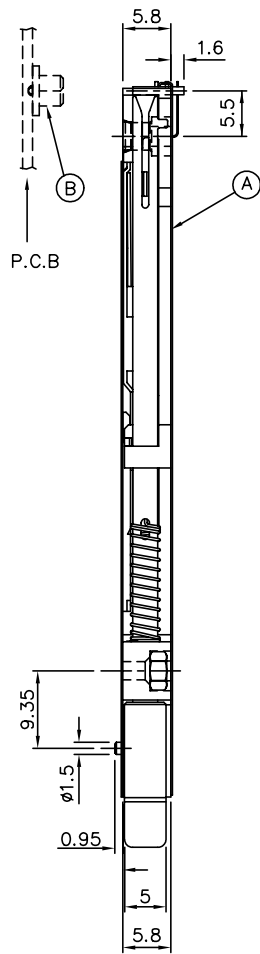
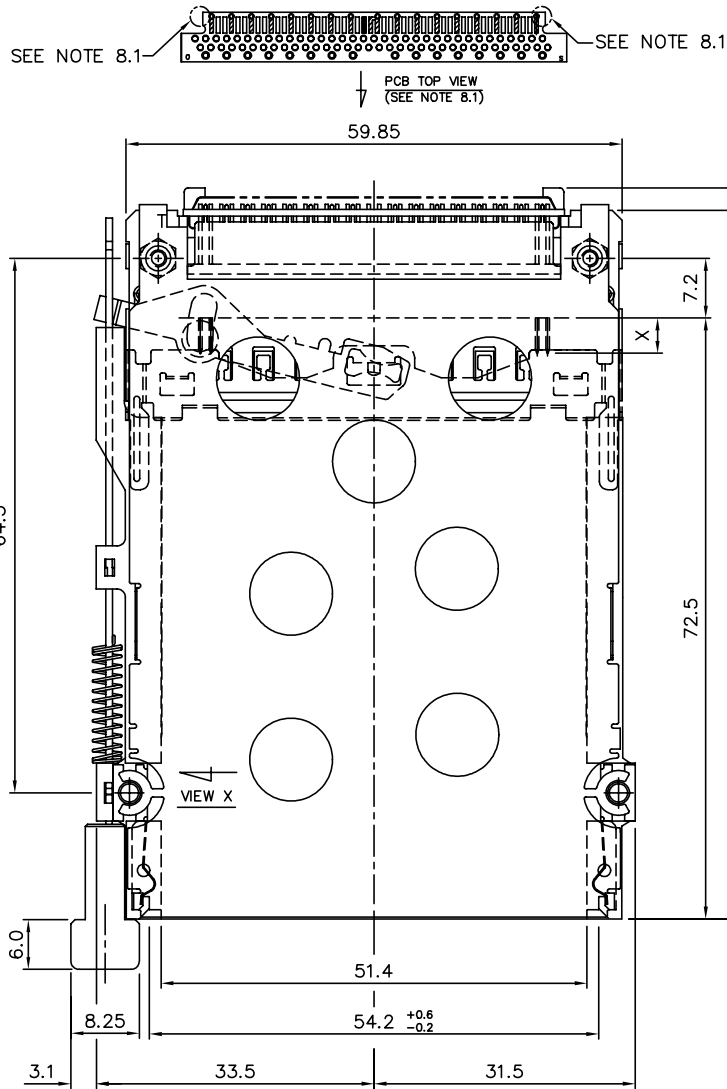
ORDERING INFORMATION

NAME	PART NO.	Q'TY
(A) EJECT HEADER ASS'Y	52366-100DAS/100DASLF	1
(B) MATING RECEPTACLE	73277-101002/101002LF	1

mat'l code				tolerance unless otherwise specified		CUSTOMER COPY		FCJ www.fcjconnect.com	
rev.	ecn no.	dr	date	linear	± 0.30	projection	title	CARDBUS EJECT HEADER	code
A	T90248	WL	07/06/99						
B	T90287	WL	08/03/99	angles	± 2°	product family : PCMCIA	size	dwg no.	TWN
C	T90359	WL	10/14/99						
D	T00105	WL	04/11/00	dr	WENDY CHEN	06/25/99	unit	mm/inch	sheet
E	T10151	WL	05/28/01	enr	STELAR CHU	06/25/99	scale	1.5:1	1 OF 3
F	N05-0037	WB	02/16/05	chr	JOSEPH HSIAO	06/25/99			
G	ELX-N-011388	ZK	04/02/12	appd	JENN TSAO	06/25/99			
sheet	revision	G	G	G					
index	sheet	1	2	3					

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PRODUCT NO.  
52366-300DAS/300DASLF



NOTES:

- 1 8.0mm MIN CARD EJECT.
- 2 EJECT TRAVEL: 9.50mm
- 3 MATERIAL:  
EJECT HEADER ASS'Y  
PLASTIC HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PIN: COPPER ALLOY  
PCB: FR4  
PLASTIC GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK  
PLATE: STAINLESS  
EMI CONTACT: PHOSPHOR BRONZE
- 4 FINISH  
PIN :  
UNDER PLATING: 0.5um MIN. Ni  
CONTACT AREA: 0.076 µm MIN. GOLD  
  
SOLDER TAIL(TIN LEAD OPTION): 2.5um MIN. Sn-Pb  
SOLDER TAIL(LEAD FREE OPTION): 2.5um MIN. PURE TIN  
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- 6 DIM "X"
 

4.25±0.1	3.5±0.1	5.0±0.1
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- 10 IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008
- 11 LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
- 12 PRODUCT SPEC:110-263

ORDERING INFORMATION

NAME	PART NO.	Q'TY
Ⓐ EJECT HEADER ASS'Y	52366-300DAS/300DASLF	1
Ⓑ MATING RECEPTACLE	73277-101002/101002LF	1

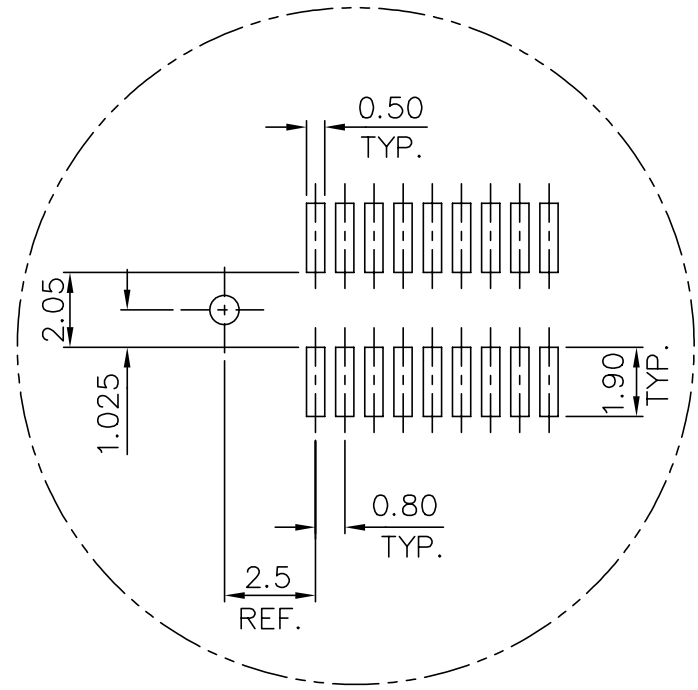
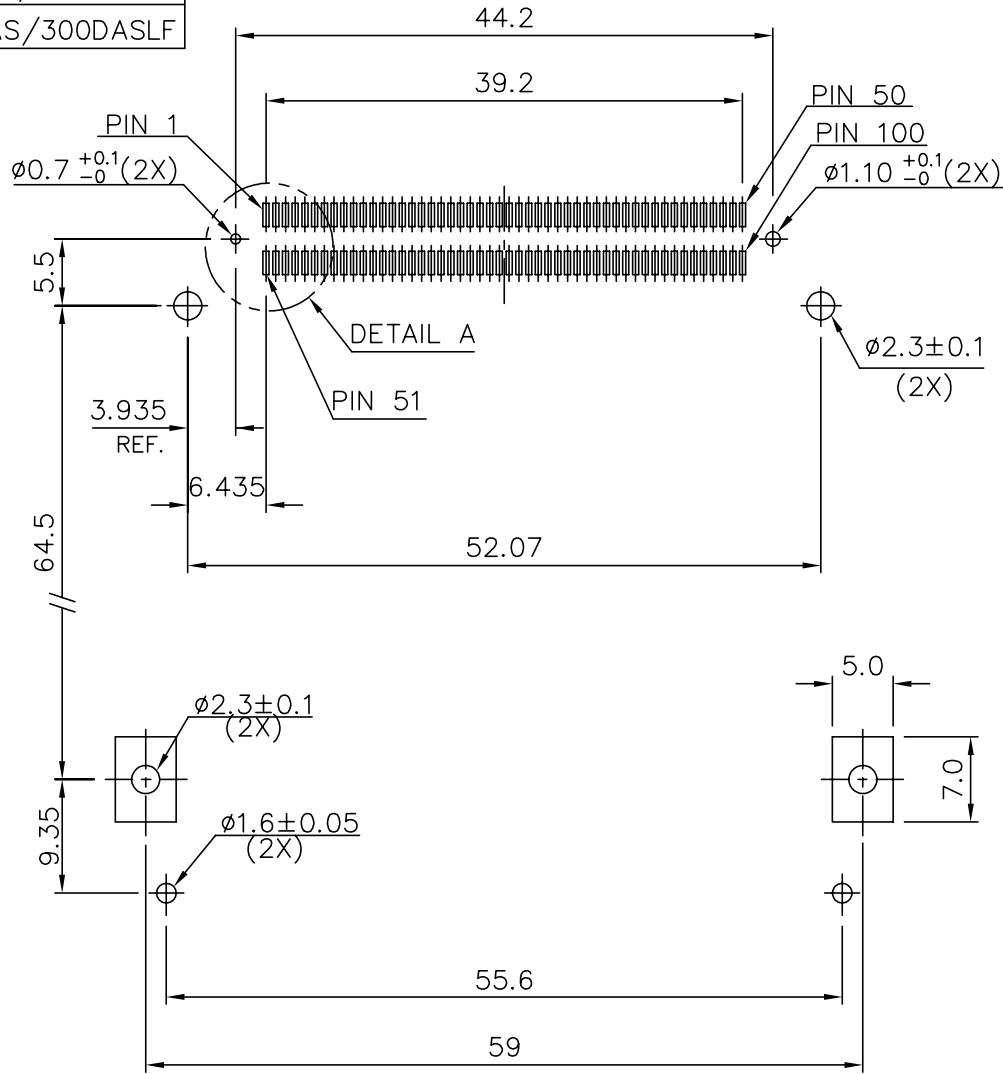
mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		 www.fcjconnect.com	
rev.	ecn no.	dr	date	linear	projection		
G				± 0.30		product family : PCMCIA	
				angles ± 2°		code	
				dr WENDY CHEN 06/25/99	unit	sheet	
				enrg STELAR CHU 06/25/99	mm/inch	TWN	
				chr JOSEPH HSIAO 06/25/99	scale	2 of	
				app JENN TSAO 06/25/99	1.5:1	A3	
sheet	revision					52366	
index	sheet						

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PRODUCT NO.
52366-100DAS/100DASLF
52366-300DAS/300DASLF



DETAIL A

4 CARD INSERTION DIRECTION

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	www.fcjconnect.com		
rev.	ecn no.	dr	date	linear	± 0.10	projection 	title CARDBUS EJECT HEADER SMT, TYPE 1/2/3
G							
				angles	± 2°		
		dr	WENDY CHEN 06/25/99	unit	mm/inch	product family : PCMCIA	code
		enrg	STELAR CHU 06/25/99	scale	2:1	size dwg no.	TWN
		chr	JOSEPH HSIAO 06/25/99			52366	sheet
		appd	JENN TSAO 06/25/99				3 OF
sheet	revision						
index	sheet						